

Cypress Semiconductor Corporation

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San Jose, CA 95134, USA

Note: This is an electronically printed document, hence, no signature is required

RoHS Certificate of Compliance (RoHS II)

This is to certify that the parts/products listed in Appendix A meet the requirements of the **RoHS II** on the restriction of the use of certain hazardous substances for the following five restricted materials and their respective allowable limits with the exception of lead (Pb). Any Lead (Pb) present in the listed products resides only in the lead plating or in the solder balls in the case of BGA's.

| RoHS Restricted Substance | Allowable Limit |
|---------------------------------------|-------------------------|
| Cadmium and its compounds | 100 ppm (0.01 weight %) |
| Mercury and its compounds | 1000 ppm (0.1 weight %) |
| Hexavalent chromium and its compounds | 1000 ppm (0.1 weight %) |
| Polybrominated biphenyls (PBB) | 1000 ppm (0.1 weight %) |
| Polybrominated diphenyl ethers (PBDE) | 1000 ppm (0.1 weight %) |
| Hexabromocyclododecane (HBCDD) | 1000 ppm (0.1 weight %) |
| Bis(2-ethylhexyl) phthalate (DEHP) | 1000 ppm (0.1 weight %) |
| Butyl benzyl phthalate (BBP) | 1000 ppm (0.1 weight %) |
| Dibutyl phthalate (DBP) | 1000 ppm (0.1 weight %) |
| Diisobutyl phthalate (DIBP) | 1000 ppm (0.1 weight %) |

Date: April 19, 2021

Appendix A

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